



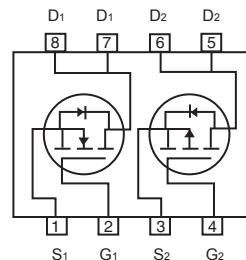
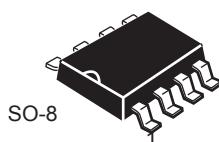
CEM4309

Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRELIMINARY

FEATURES

- 40V, 5.8A, $R_{DS(ON)} = 38m\Omega$ @ $V_{GS} = 10V$.
 $R_{DS(ON)} = 50m\Omega$ @ $V_{GS} = 4.5V$.
- -40V, -4.1A, $R_{DS(ON)} = 67m\Omega$ @ $V_{GS} = -10V$.
 $R_{DS(ON)} = 106m\Omega$ @ $V_{GS} = -4.5V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handing capability.
- Lead free product is acquired.
- Surface mount Package.



ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ C$ unless otherwise noted

Parameter	Symbol	N-Channel	P-Channel	Units
Drain-Source Voltage	V_{DS}	40	-40	V
Gate-Source Voltage	V_{GS}	± 20	± 20	V
Drain Current-Continuous	I_D	5.8	-4.1	A
Drain Current-Pulsed ^a	I_{DM}	23	-16	A
Maximum Power Dissipation	P_D	2.0		W
Operating and Store Temperature Range	T_J, T_{Stg}	-55 to 150		°C

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Ambient ^b	$R_{\theta JA}$	62.5	°C/W



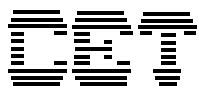
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N-Channel Electrical Characteristics $T_A = 25\text{ C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 40\text{V}, V_{GS} = 0\text{V}$			1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{GS} = 20\text{V}, V_{DS} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{GS} = -20\text{V}, V_{DS} = 0\text{V}$			-100	nA
On Characteristics^c						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	1		3	V
Static Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 5.8\text{A}$		32	38	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{DS} = 15\text{V}, I_D = 5.8\text{A}$		40	50	$\text{m}\Omega$
Dynamic Characteristics^d						
Input Capacitance	C_{iss}	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}, f = 1.0 \text{ MHz}$		680		pF
Output Capacitance	C_{oss}			110		pF
Reverse Transfer Capacitance	C_{rss}			65		pF
Switching Characteristics^d						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 20\text{V}, I_D = 5.8\text{A}, V_{GS} = 10\text{V}, R_{GEN} = 3\Omega$		11	22	ns
Turn-On Rise Time	t_r			3	6	ns
Turn-Off Delay Time	$t_{d(off)}$			26	52	ns
Turn-Off Fall Time	t_f			3	6	ns
Total Gate Charge	Q_g	$V_{DS} = 20\text{V}, I_D = 5.8\text{A}, V_{GS} = 4.5\text{V}$		6.4	8.5	nC
Gate-Source Charge	Q_{gs}			1.7		nC
Gate-Drain Charge	Q_{gd}			2.8		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current ^b	I_S				5.8	A
Drain-Source Diode Forward Voltage ^c	V_{SD}	$V_{GS} = 0\text{V}, I_S = 1.9\text{A}$			1.3	V

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature.□
- b.Surface Mounted on FR4 Board, t ≤ 10 sec.□
- c.Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.□
- d.Guaranteed by design, not subject to production testing.□

**P-Channel Electrical Characteristics** $T_A = 25\text{ C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -40\text{V}, V_{GS} = 0\text{V}$			-1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{GS} = 20\text{V}, V_{DS} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{GS} = -20\text{V}, V_{DS} = 0\text{V}$			-100	nA
On Characteristics^b						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-1		-3	V
Static Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = -10\text{V}, I_D = -4.1\text{A}$		56	67	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{DS} = -10\text{V}, I_D = -4.1\text{A}$		86	106	$\text{m}\Omega$
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{DS} = -20\text{V}, V_{GS} = 0\text{V}, f = 1.0 \text{ MHz}$		700		pF
Output Capacitance	C_{oss}			120		pF
Reverse Transfer Capacitance	C_{rss}			70		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -15\text{V}, I_D = -1\text{A}, V_{GS} = -10\text{V}, R_{GEN} = 6\Omega$		12	25	ns
Turn-On Rise Time	t_r			2	4	ns
Turn-Off Delay Time	$t_{d(off)}$			30	60	ns
Turn-Off Fall Time	t_f			4	8	ns
Total Gate Charge	Q_g	$V_{DS} = -20\text{V}, I_D = -4.1\text{A}, V_{GS} = -4.5\text{V}$		5.6	7.4	nC
Gate-Source Charge	Q_{gs}			1.9		nC
Gate-Drain Charge	Q_{gd}			2.5		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S				-4.1	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{GS} = 0\text{V}, I_S = -1.3\text{A}$			-1.2	V

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature.
- b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- c.Guaranteed by design, not subject to production testing.



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N-CHANNEL

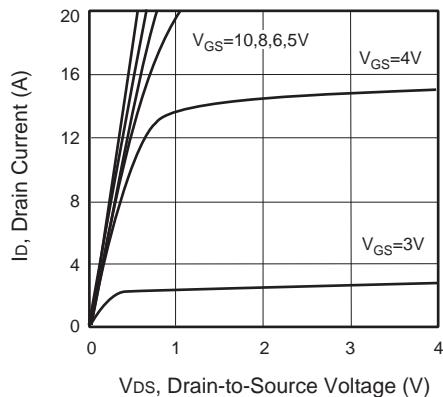


Figure 1. Output Characteristics

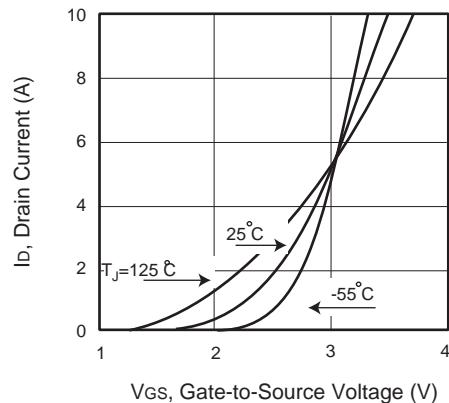


Figure 2. Transfer Characteristics

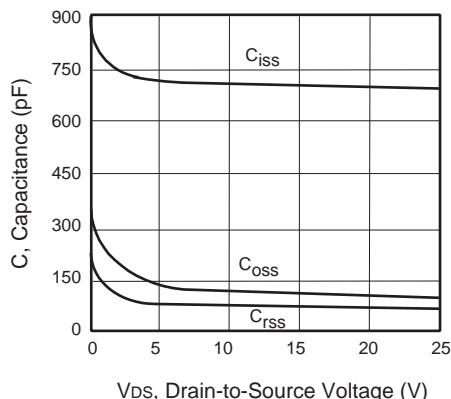


Figure 3. Capacitance

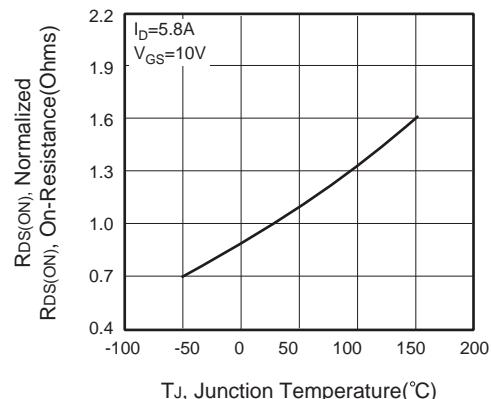


Figure 4. On-Resistance Variation with Temperature

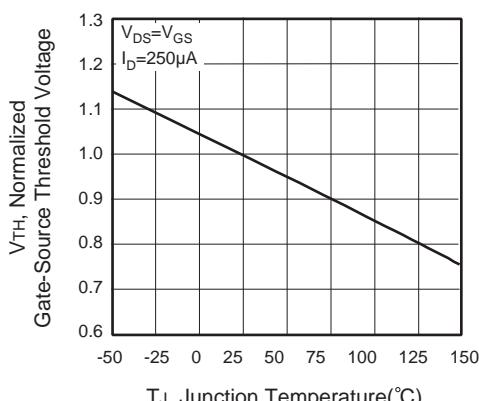


Figure 5. Gate Threshold Variation with Temperature

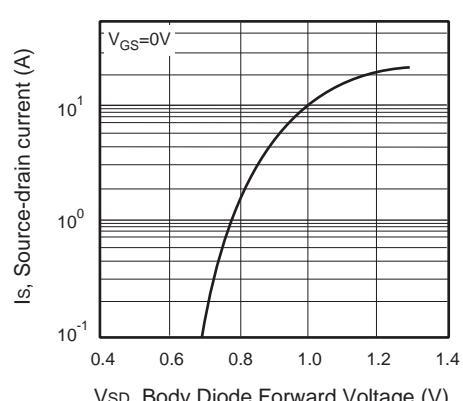
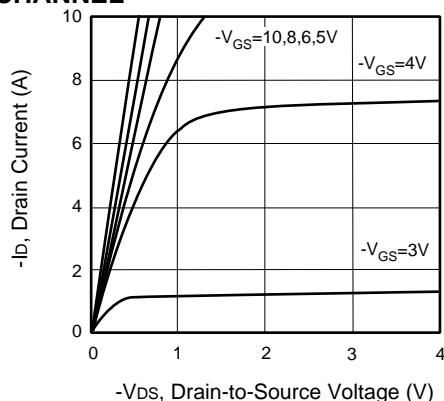
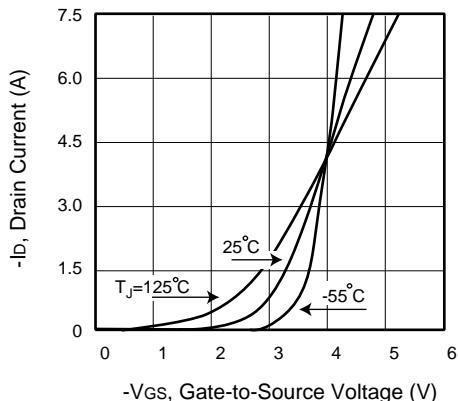
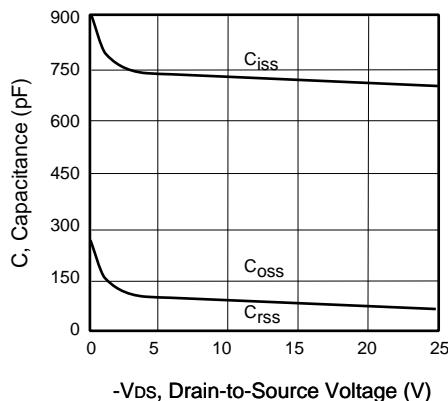
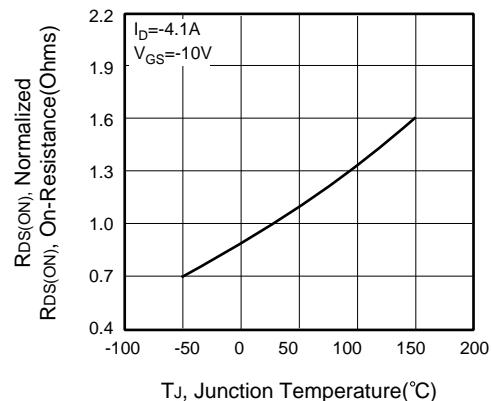
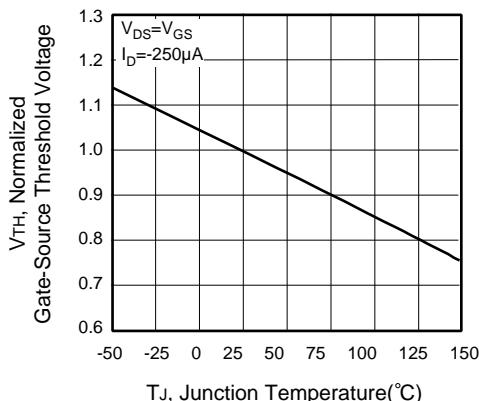
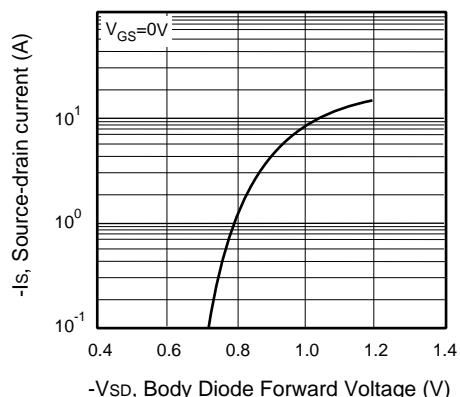
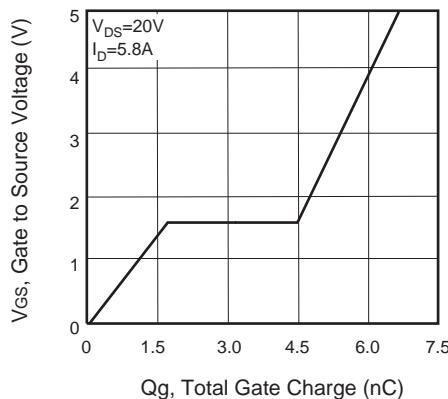
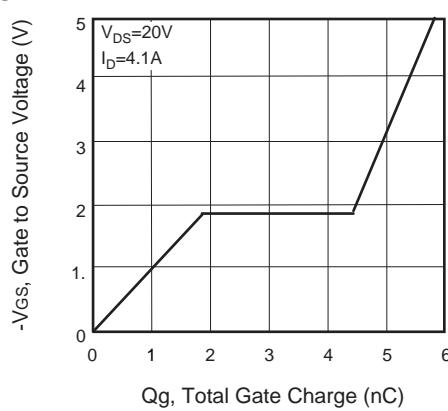
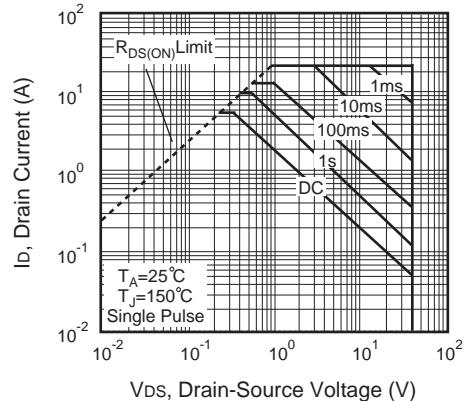
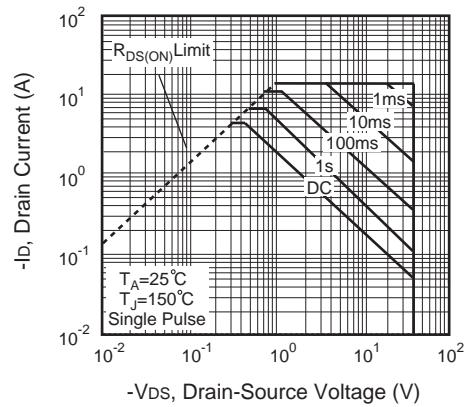


Figure 6. Body Diode Forward Voltage Variation with Source Current

P-CHANNEL

Figure 1. Output Characteristics

Figure 2. Transfer Characteristics

Figure 3. Capacitance

Figure 4. On-Resistance Variation with Temperature

Figure 5. Gate Threshold Variation with Temperature

Figure 6. Body Diode Forward Voltage Variation with Source Current

N-CHANNEL**Figure 13. Gate Charge****P-CHANNEL****Figure 15. Gate Charge****Figure 14. Maximum Safe Operating Area****Figure 16. Maximum Safe Operating Area**

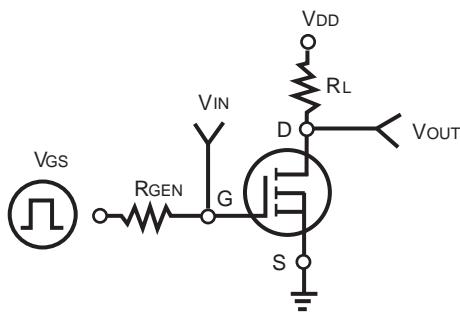


Figure 17. Switching Test Circuit

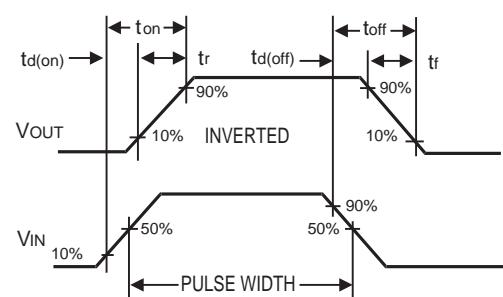


Figure 18. Switching Waveforms

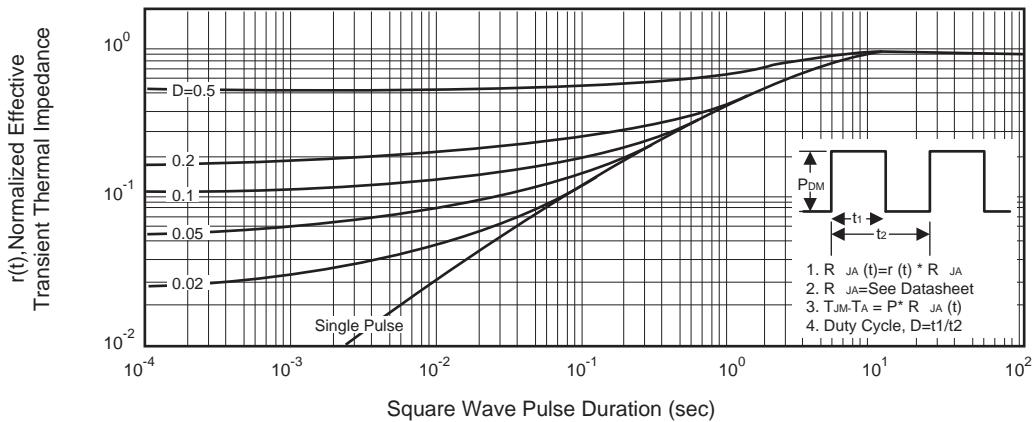


Figure 19. Normalized Thermal Transient Impedance Curve